Product data sheet

1. General description

Ultrafast power diode in a SOD113 (2-lead TO-220F) plastic package.

2. Features and benefits

- Fast switching
- Low forward voltage drop
- Soft recovery characteristic

3. Applications

- Discontinuous Current Mode (DCM) Power Factor Correction (PFC)
- · High frequency switched-mode power supplies
- TV power supplies

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	l l	Min	Тур	Max	Unit
V_{RRM}	repetitive peak reverse voltage			-	-	800	V
I _{F(AV)}	average forward current	δ = 0.5 ; T _h ≤ 88 °C; square-wave pulse; Fig. 1; Fig. 2; Fig. 3		-	-	8	А
I _{FRM}	repetitive peak forward current	δ = 0.5 ; t_p = 25 µs; $T_h \le 88$ °C; square-wave pulse	-	-	-	16	Α
IFSM	non-repetitive peak forward current	t_p = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse; Fig. 4	-	-	-	80	Α
		t_p = 8.3 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse; Fig. 4	-	-	-	88	Α
Static characteristics							
V_{F}	forward voltage	I _F = 8 A; T _j = 25 °C; <u>Fig. 6</u>	-	-	1.4	1.7	V
		I _F = 8 A; T _j = 150 °C; <u>Fig. 6</u>	-		1.2	1.5	V
Dynamic characteristics							
t _{rr}	reverse recovery time	$I_F = 1 \text{ A}$; $V_R = 30 \text{ V}$; $dI_F/dt = 100 \text{ A/}\mu\text{s}$; $T_j = 25 \text{ °C}$; Fig. 7	-	-	40	55	ns

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode	mb	K — A
2	Α	anode		001aaa020
mb	n.c.	mounting base; isolated	TO-220F (SOD113)	

6. Limiting values

Table 3. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{RRM}	repetitive peak reverse voltage		-	800	V
V_{RWM}	crest working reverse voltage		-	800	V
V_R	reverse voltage	DC	-	800	V
I _{F(AV)}	average forward current	δ = 0.5 ; T _h ≤ 88 °C; square-wave pulse; Fig. 1; Fig. 2; Fig. 3	-	8	Α
I _{FRM}	repetitive peak forward current	δ = 0.5 ; t_p = 25 µs; $T_h \le 88$ °C; squarewave pulse	-	16	Α
I _{FSM}	non-repetitive peak forward current	t_p = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse; Fig. 4	-	80	Α
		t_p = 8.3 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse; Fig. 4	-	88	Α
T _{stg}	storage temperature		-40	175	°C
Tj	junction temperature		-	175	°C

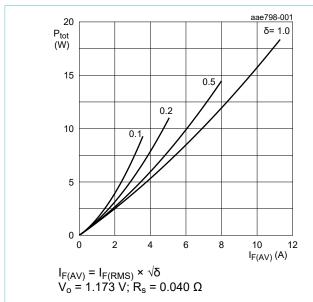
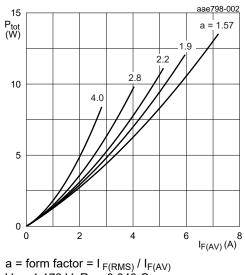


Fig. 1. Forward power dissipation as a function of average forward current; square waveform; maximum values



a = form factor = I $_{F(RMS)}$ / I $_{F(AV)}$ V $_{o}$ = 1.173 V; R $_{s}$ = 0.040 $_{\Omega}$

Fig. 2. Forward power dissipation as a function of average forward current; sinusoidal waveform; maximum values

WeEn Semiconductors BYR29X-800P

Ultrafast power diode

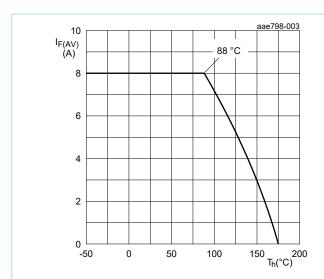


Fig. 3. Forward current as a function of heatsink temperature; maximum values

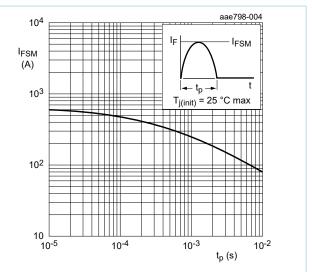


Fig. 4. Non-repetitive peak forward current as a function of pulse width; sinusoidal waveform; maximum values

7. Thermal characteristics

Table 4. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-h)}	thermal resistance from junction to heatsink	with heatsink compound; Fig. 5	-	-	6	K/W
$R_{th(j-a)}$	thermal resistance from junction to ambient free air	in free air	-	60	-	K/W

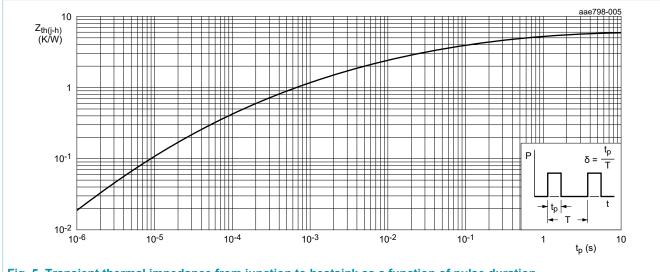
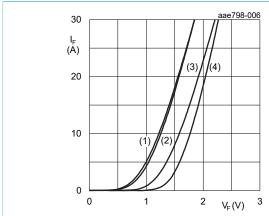


Fig. 5. Transient thermal impedance from junction to heatsink as a function of pulse duration

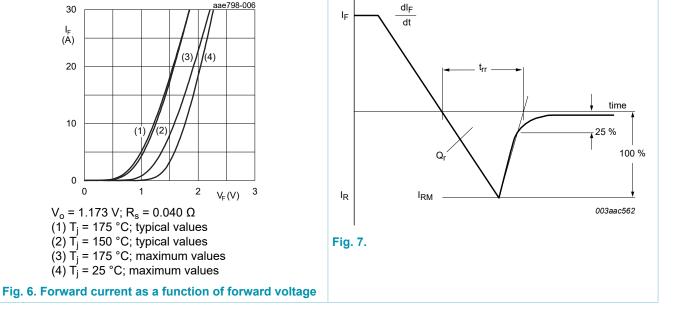
8. Characteristics

Table 5. Characteristics

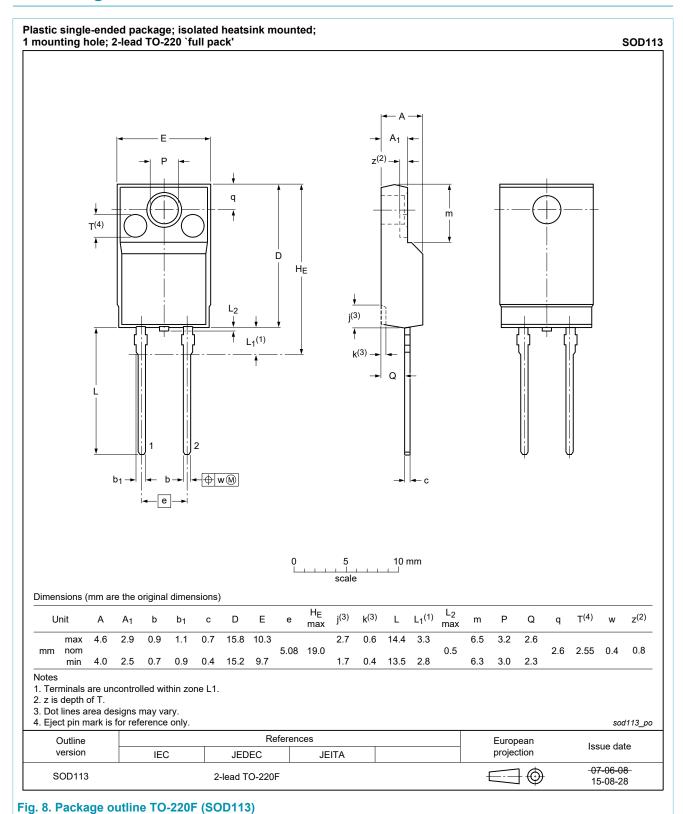
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Static characteristics							
V _F	forward voltage	I _F = 8 A; T _j = 25 °C; <u>Fig. 6</u>		-	1.4	1.7	V
		I _F = 8 A; T _j = 150 °C; <u>Fig. 6</u>		-	1.2	1.5	V
I _R	reverse current	V _R = 800 V; T _j = 25 °C		-	-	10	μA
		V _R = 800 V; T _j = 150 °C		-	-	0.2	mA
Dynamic characteristics							,
Q _r	recovered charge	$I_F = 2 \text{ A}$; $V_R = 30 \text{ V}$; $dI_F/dt = 20 \text{ A/s}$; $T_j = 25 \text{ °C}$		-	60	110	nC
t _{rr}	reverse recovery time	$I_F = 1 \text{ A}$; $V_R = 30 \text{ V}$; $dI_F/dt = 100 \text{ A/}\mu\text{s}$; $T_j = 25 \text{ °C}$; Fig. 7		-	40	55	ns
I _{RM}	peak reverse recovery current	$I_F = 1 \text{ A}$; $V_R = 30 \text{ V}$; $dI_F/dt = 100 \text{ A/}\mu\text{s}$; $T_j = 25 \text{ °C}$		-	-	5	Α



 V_o = 1.173 V; R_s = 0.040 Ω (1) T_j = 175 °C; typical values (2) T_j = 150 °C; typical values (3) T_j = 175 °C; maximum values (4) T_j = 25 °C; maximum values



9. Package outline



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10. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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